

# Monitoring and Management of Data Centers in the Internet-of-Things Era

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# Current Information and Communication Technology (IT) Ecosystem

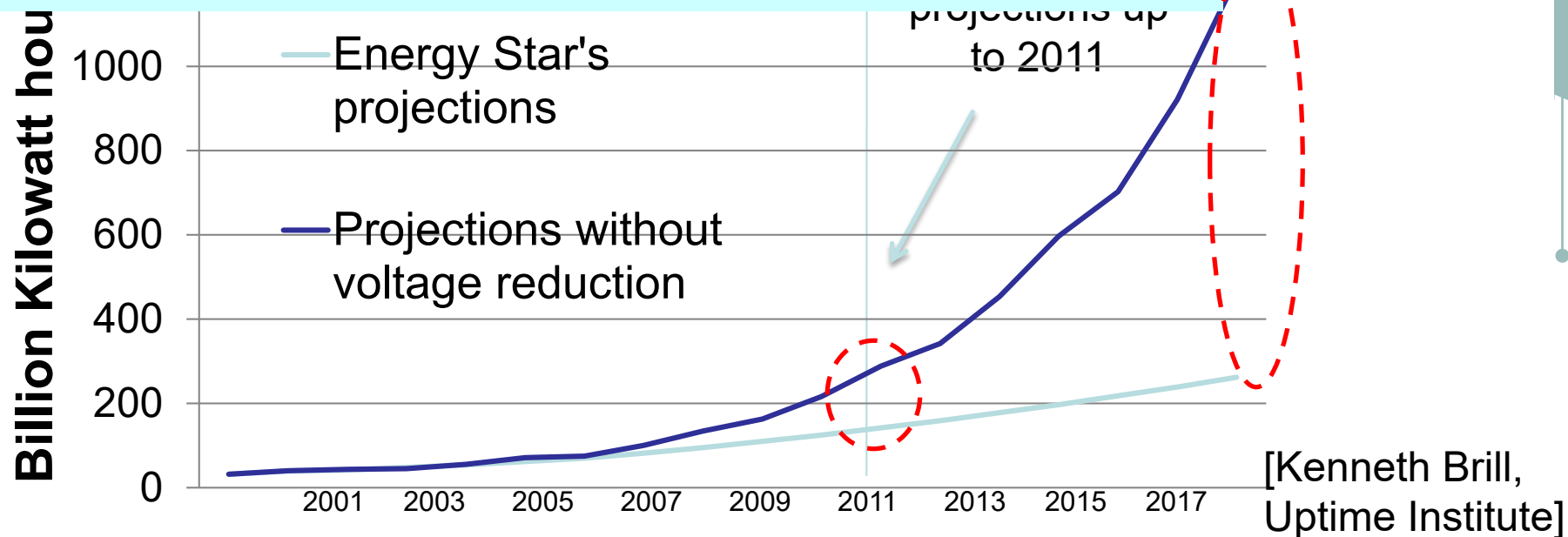


- ICT ecosystem encompasses:
  - Multi-level computing: edge, switching centers and cloud
  - Core part of computing at hyperscale data centers (DCs)

# Why an energy problem? Power Density in Computing Systems: “Economic Meltdown of Moore’s Law”

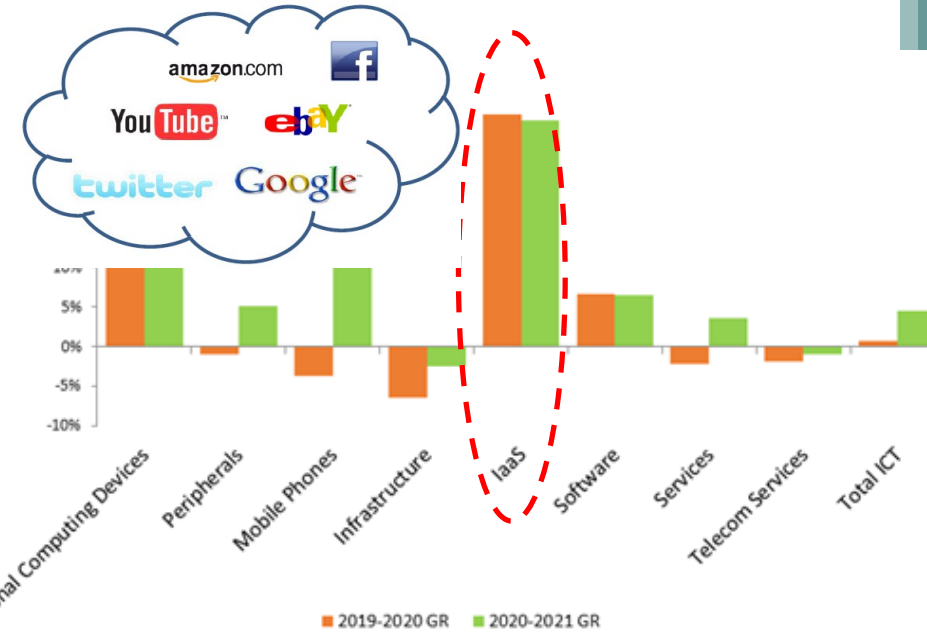
- 45 years of IT industry & Moore’s law being discontinued
  - 2x more transistors every 2 years, quadratic energy reduction (voltage)
  - Voltages have leveled, ITRS projections in 2000 for voltage levels in 2011 were 40% lower...

**Dramatic increase in energy usage every new IT generation (80% more than expected today!)**

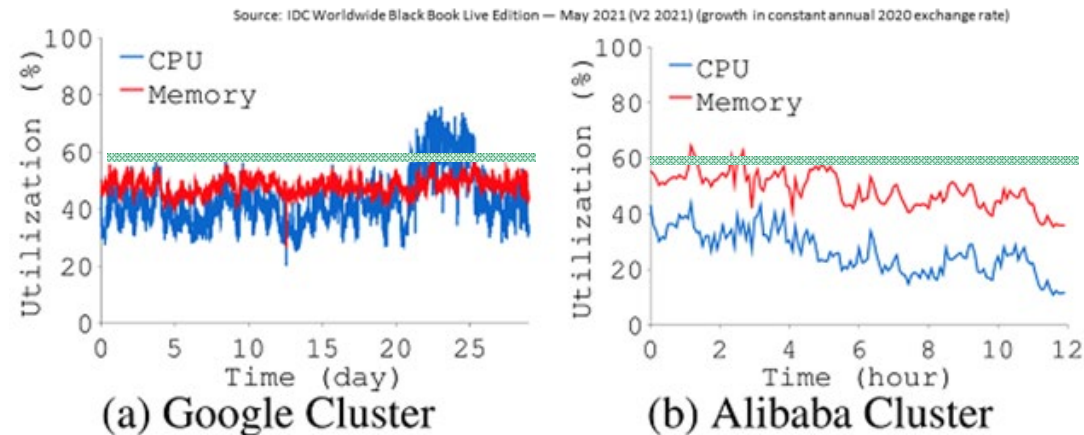
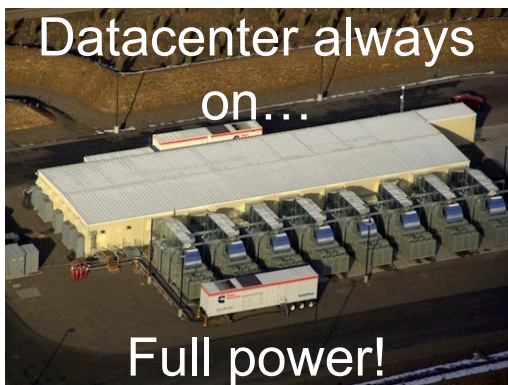


# Ineffective Data Centers: Large Energy Expenditure... And Not Even Well Used!

- Cloud computing is... Growing always!
  - Amazon: \$1 billion profits annually
  - Infrastructure as a Service (IaaS): Data Centers (DCs) = essence of Cloud



- Datacenters electricity can reach 8% worldwide electricity by 2030 [IDC]

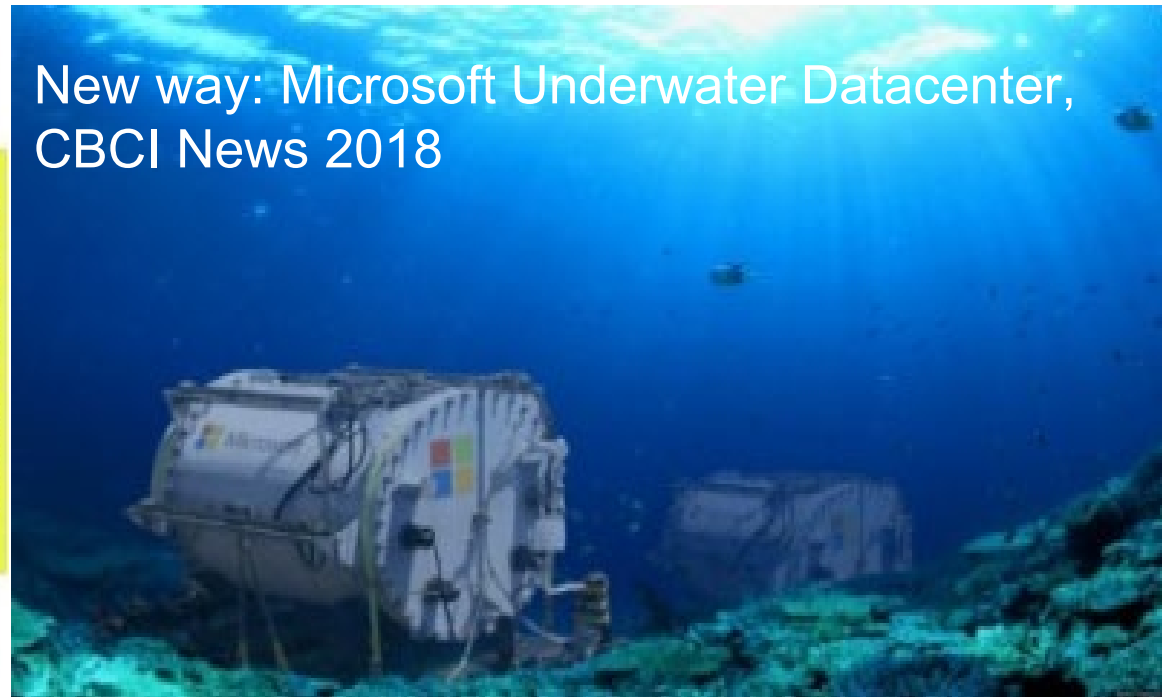


**But typically used at 60-65% of capacity!**

# Current DC Design Is Not Optimal



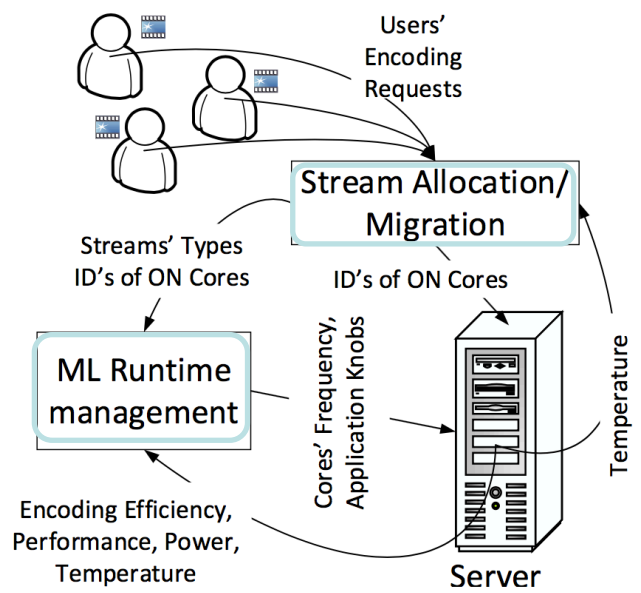
New way: Microsoft Underwater Datacenter, CBCI News 2018



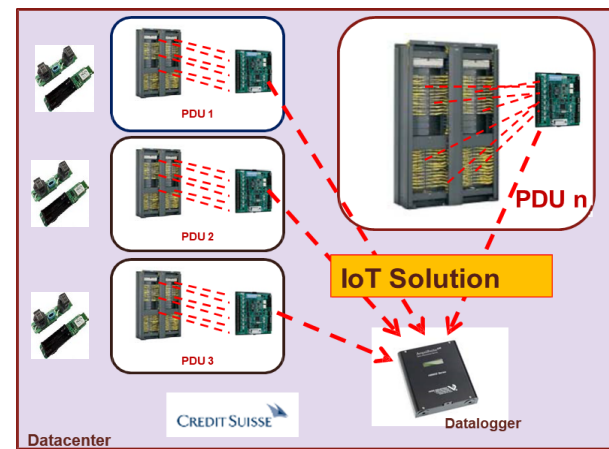
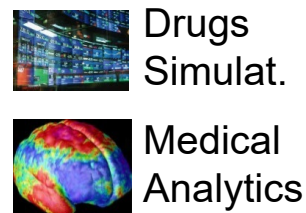
- Segregation of tasks: **multi-scale** modeling problem (components choice, applications, etc.)
  - Not clear communication of knowledge from one layer to another
  - IT equipment and cooling (over)provisioned separately to increase resilience
- Current DCs are **energy inefficient**
  - Power-cooling need as much energy as IT equipment... and thrown away
  - **For an 18 MW datacenter : Up to US\$ 2.5M wasted per year!**

# YINS: Thermal-Aware Design for Next Generation Energy-Efficient Data Centers

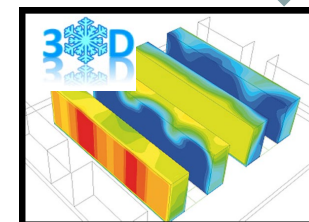
1. Use of Internet of Things (IoT) to monitor computing infrastructure: PMSM
2. Thermal/Power/Faults maps: 3D-ICE open-source multi-scale compact simulator
3. Two-step optimization approach
  - a) TheSPoT: Thermal Stress-Aware Power and Thermal Management
  - b) MAMUT: ML-based runtime management using multi-agent reinforcement learning (RL)



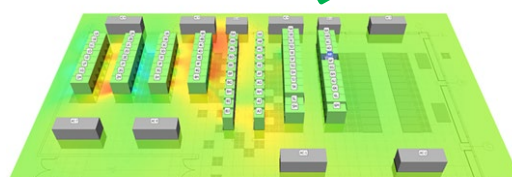
## Phase 1) Monitoring Arrival of Applications



## Phase 2) Power and Temp. Monitoring Tool

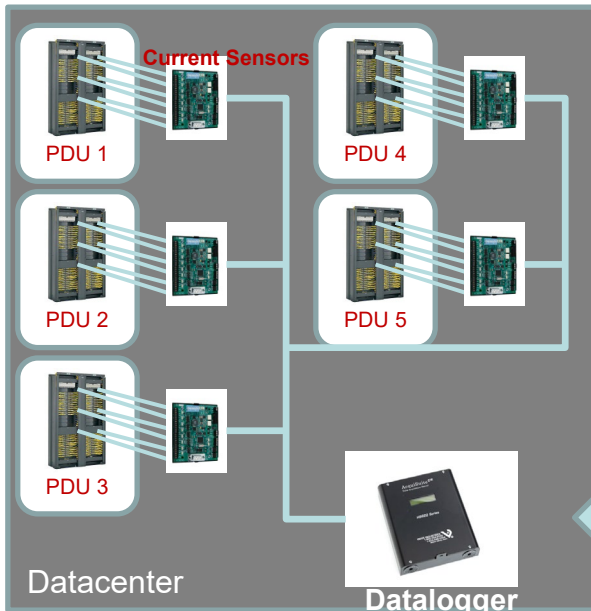


## Phase 3) Machine Learning Based Run-Time Management



# Power Monitor System and Management (PMSM)

- Real-time monitoring and automatic alerts for 3 DCs (>7,000 servers)
  - Servers monitoring using on-board sensors
  - Rack: extra IoT sensors for temp., humid. and vibrations
- System-level data center modeling/maintenance
  - Historical servers power consumption analysis: daily, weekly, monthly, ...
  - Faults detection: rack circuit breaker failure, power overload, “zombie” servers,...



In cooperation with 

See info at: <http://esl.epfl.ch/page-57400-en.html>

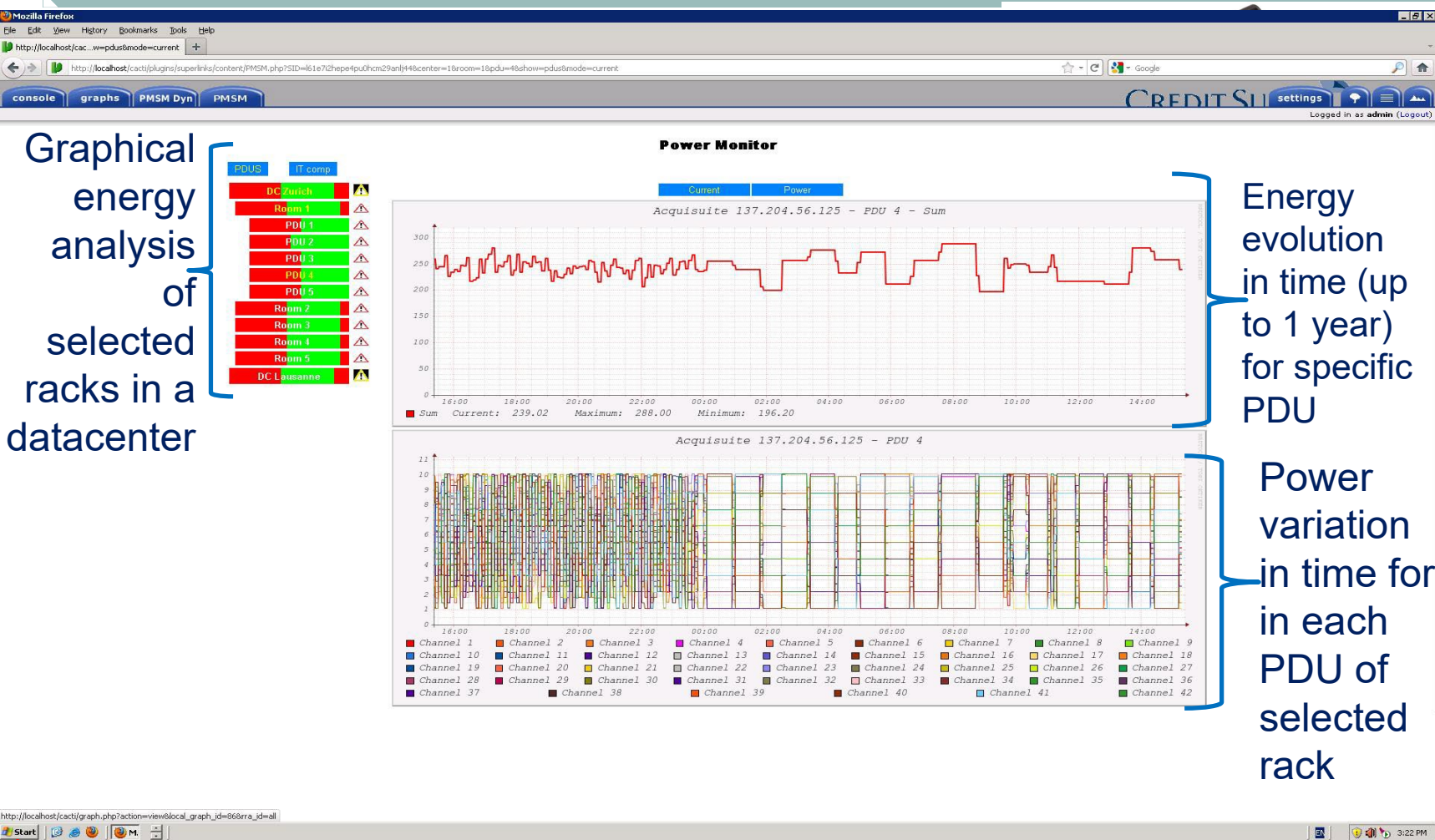
**PMSM: Data collector and Analysis server**

**PMSM: User Management Interface**



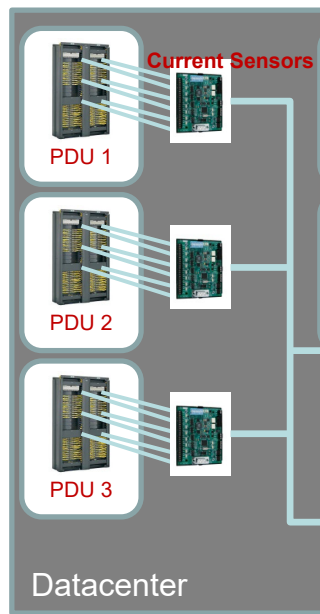
# Power Monitor System and Management (PMSM)

- Real-time in place
  - Server
  - Rack:
- System-level
  - Histori
  - Faults

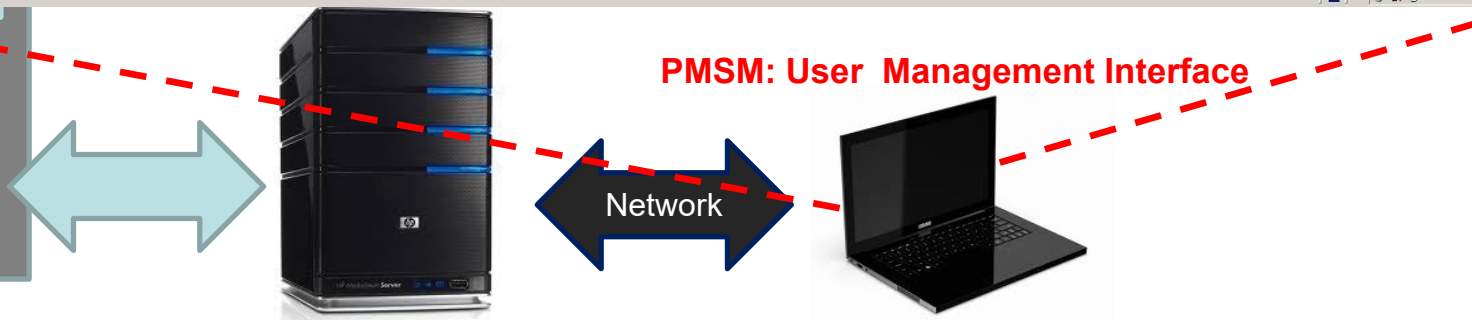


Energy evolution in time (up to 1 year) for specific PDU

Power variation in time for in each PDU of selected rack



Datalogger





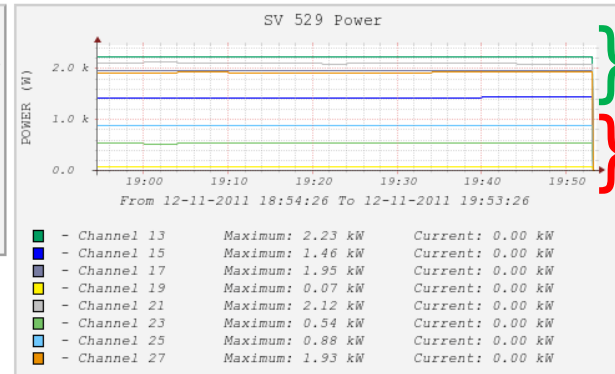
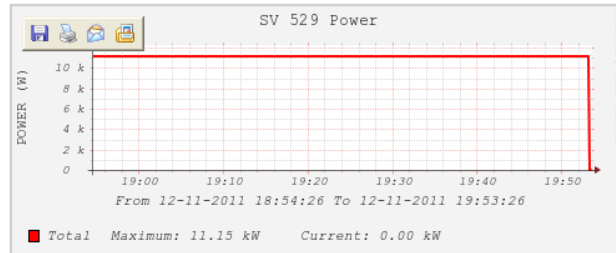
# Example Case Study: Detailed Energy Use View for Different Racks in one Credit Suisse DC



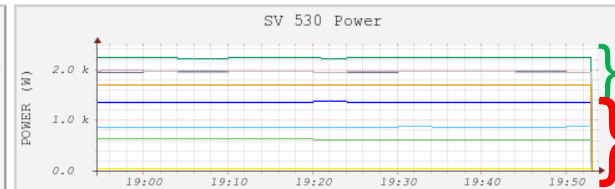
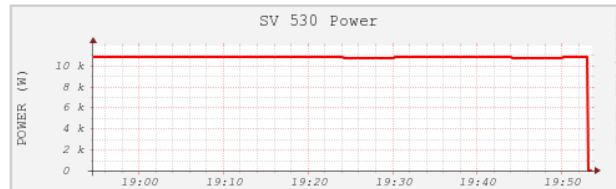
## Power Monitor

- Create
- Delete
- Racks B
- Racks A
- PDU's thumbnails

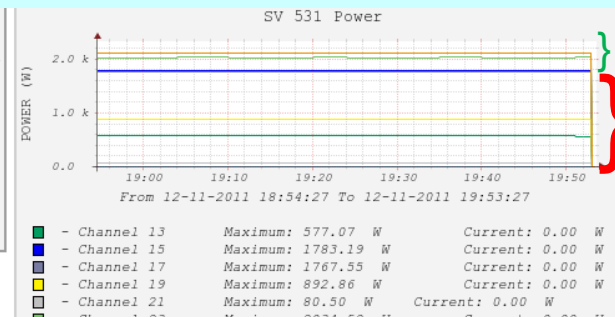
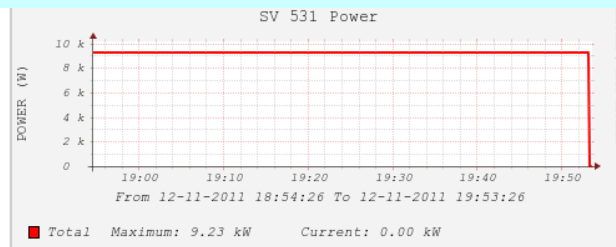
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Highly Utilized servers  
Under-utilized servers

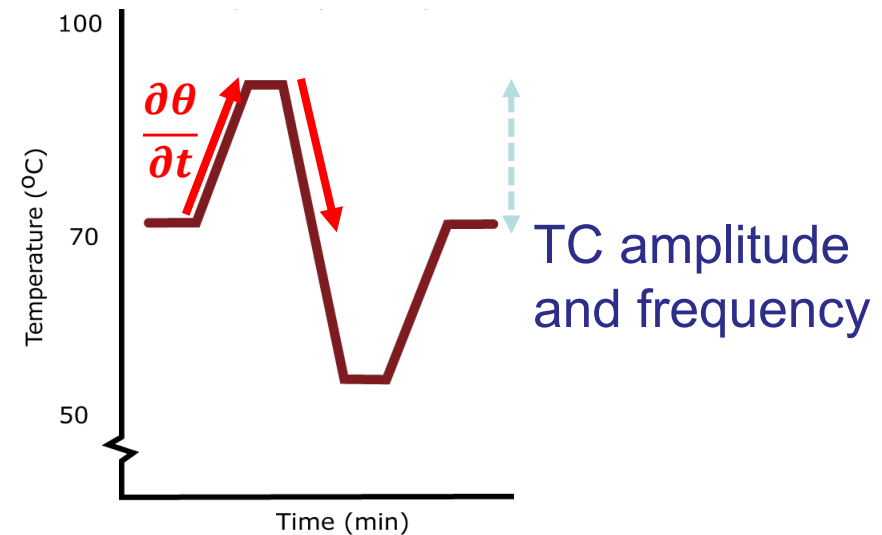
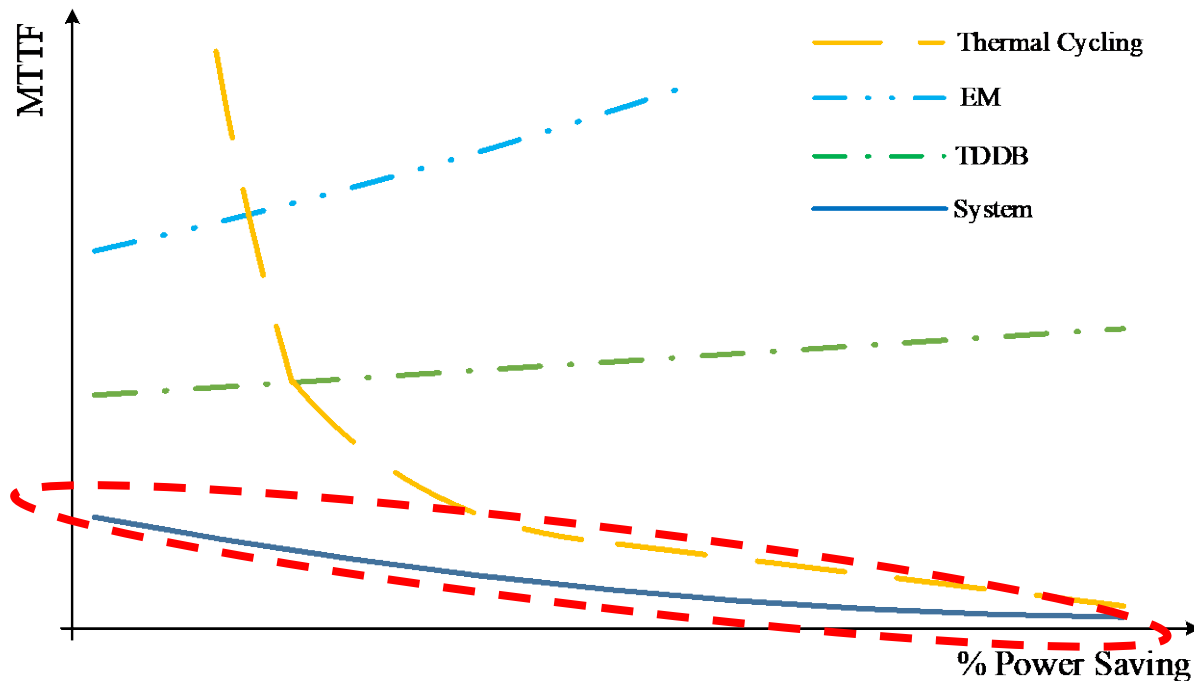
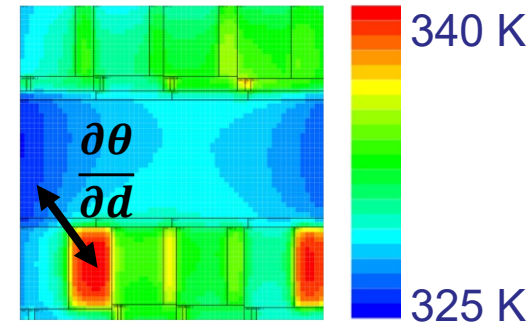


Less than 20% of servers with high/full utilization, why?  
System reliability challenge!

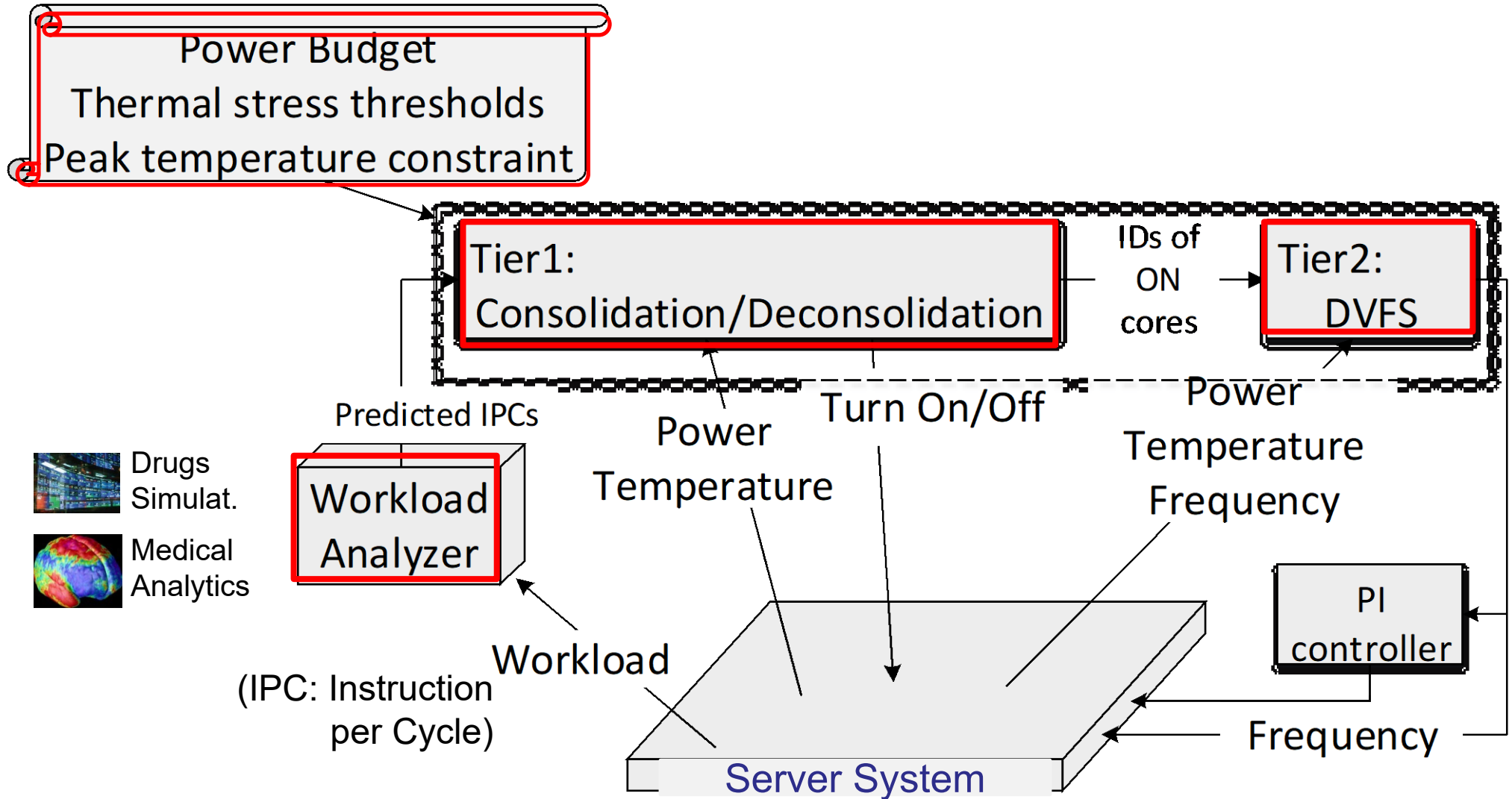


# Mean Time To Failure (MTTF) Factors: Reliability Analysis for Servers

- Traditionally hot spots (peak/average) temperature in CMOS-based electronics
  - Mechanisms: Time-Dependent Dielectric Breakdown (TDDB), Electromigration (EM), etc.
- New Mechanisms in servers: Thermal Stress
  - Spatial Thermal Gradient (STG)
  - Temporal Thermal Gradient (TTG)
  - Thermal Cycling (TC)

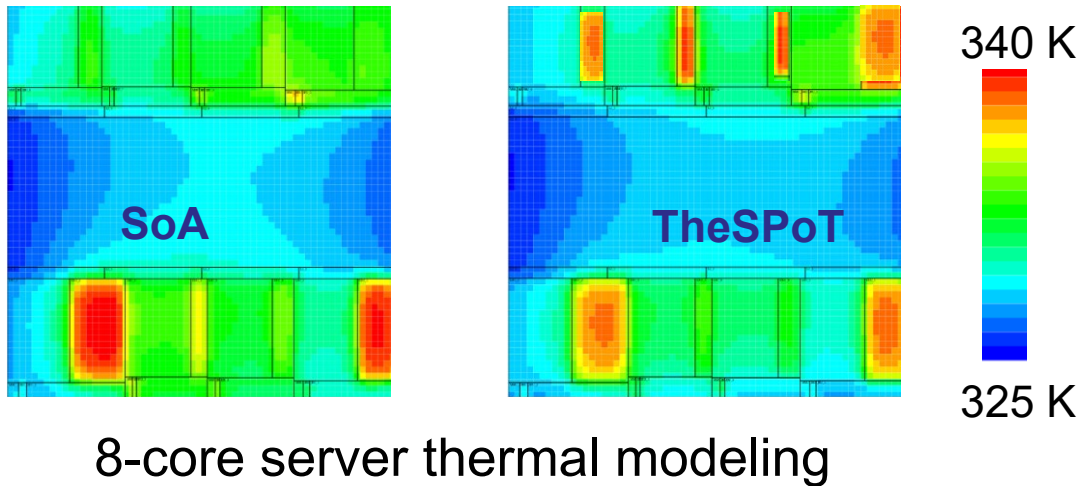


# TheSPoT: Thermal Stress-Aware Power and Thermal Management

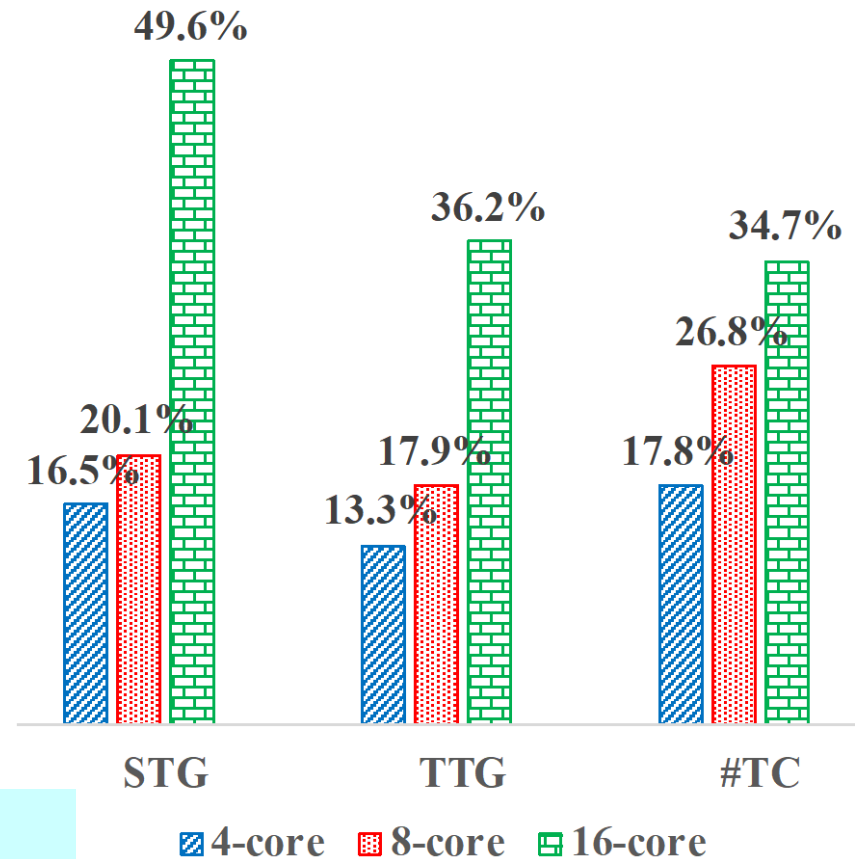


# Results: TheSPoT vs State-of-the-Art (SoA)

- Slightly higher total power in server
  - Thermal gradient less than 8°C



Improvement (%) achieved compared to SoA



**MTTF improved by 49%!**

**But how do we improve utilization?**

# MAMUT: Multi-Agent Reinforcement Learning for Efficient Real-Time Multi-User Tuning

## Actions (a):

- Application: QoS, CU
- Processor: Frequency

## States (s):

- Application: PSNR, Bitrate, Op/s
- Processor: Power, Temperature

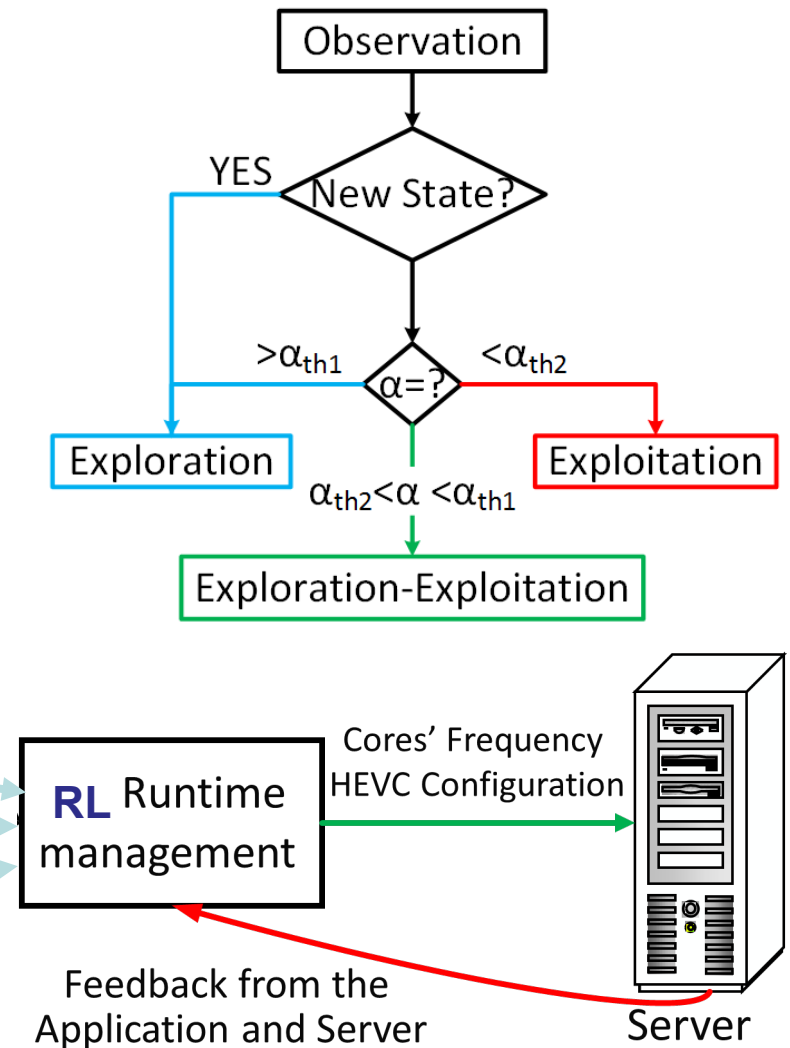
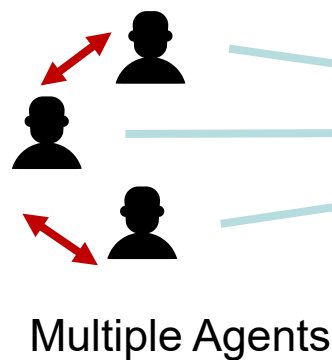
## Formulation: $\alpha_t(s_t, a_t) \stackrel{\text{def}}{=} \text{Learning Rate}$

$$\alpha_t(s_t, a_t) \propto \frac{1}{N(s_t, a_t)}$$

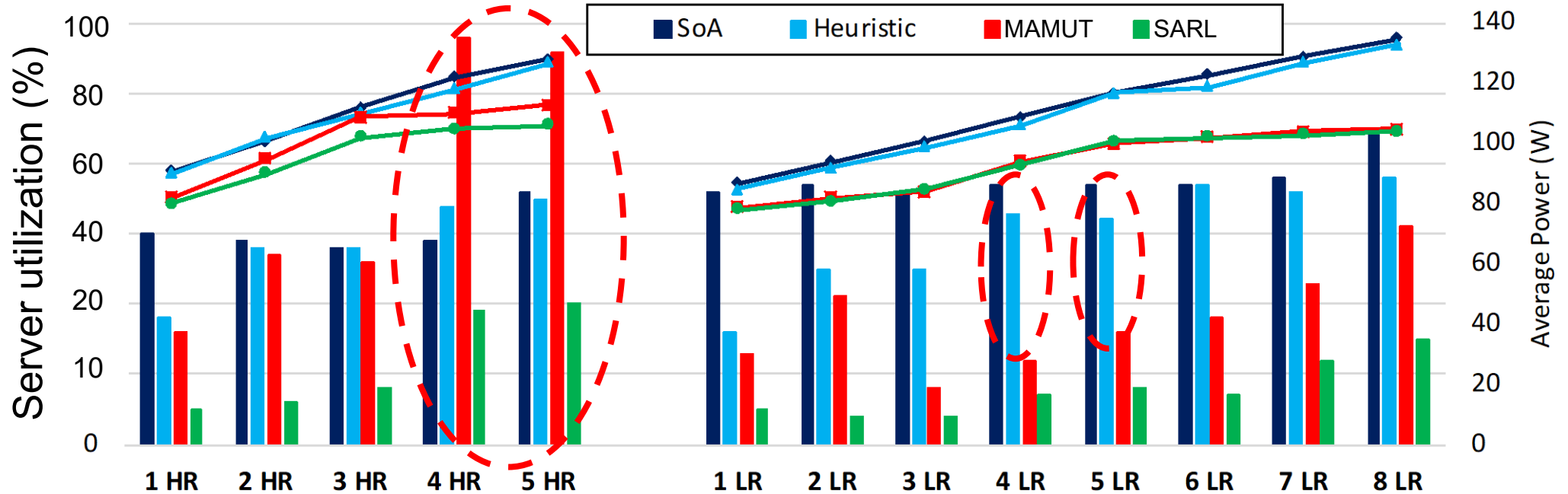
Number visits

## 3 agents:

- DVFS,
- Quality Proc. (QP),
- Number threads



# Results: MAMUT vs. SoA



Server utilization reaching 95-97% with more types of Heterogeneous Racks (HR) to manage

40-50% less power per server than SoA (but with much higher resilience thanks to TheSpot!)

# Conclusion

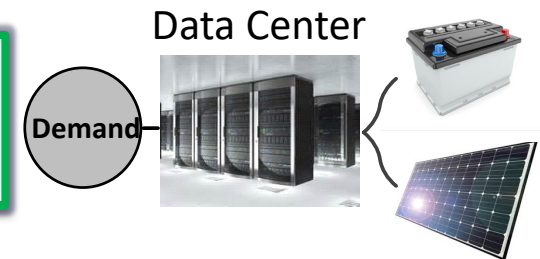
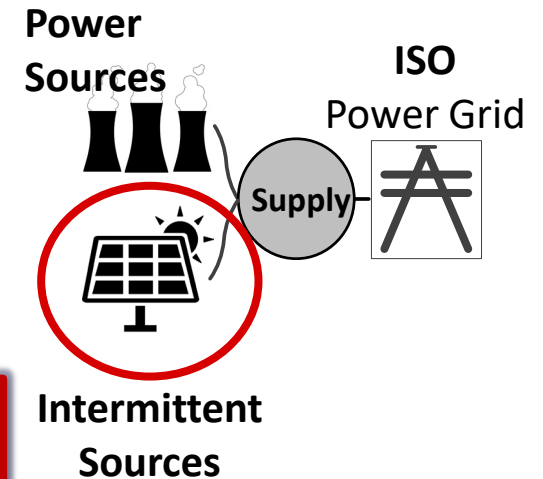
- “Green” (energy efficient) datacenters are key for ICT
  - Drastic increase of energy use on servers and cooling side
  - Sub-optimal design to prevent degraded performance/reliability
- Future: energy-reliability centric design = system-level
  - Multi-level modeling (utilization, energy, reliability, etc.)
  - Cross-layer optimizations
- IoT and Machine Learning to the rescue
  - PMSM: new sensors to understand DC operation and failures
  - TheSPoT: Thermal stress-aware power and thermal management to increase MTTF in servers (**up to 49% improvement**)
  - MARL: Multi-agent RL for efficient DC use (**up to 97% server use**)

# Future Challenges (1): Emerging Power Markets

- Integrating renewable energy on supply-side
  - EU Union targets to integrates over 20% share of renewables by 2025 [Bhringer 2019]

Challenge: high uncertainty to match supply and demand in the power grid (volatility and intermittency of renewables)

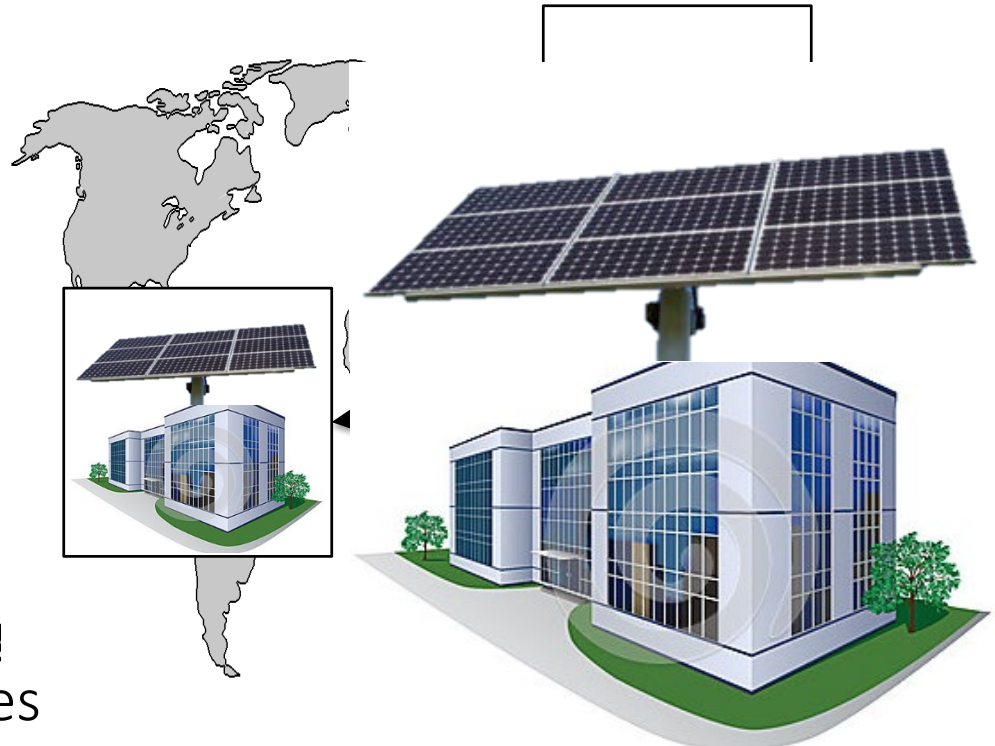
Goal: use demand-side capacity reserves, and dynamically adapt DCs power use when SLA allows it





# Future Challenges (2): Modern Geo-Distributed and Green DCs

- **Geo-distributed DCs**
  - Multiple DCs in different locations connected through network
  - **Causes:** increasing users' demands, data protection policies (e.g., GDPR)
- **And they must be green DCs!**
  - Coupled with renewable energy sources in each different places
  - Different peaks for renewables



# Conclusion

- “Green” (energy efficient) datacenters are key for IoT

- Drastic increase of energy use on servers
- Sub-optimal design to prevent degraded performance

Home > Green Tech > Power Saving

GREEN TECH POWER SAVING

Credit Suisse Zurich Datacenter Saves Up to 50% Electricity Thanks to Innovative Management System

By Ovidiu Sandru Modified date: May 30, 2017 120 1

Like 0



- Future: energy-reliability centric design

- Multi-level modeling (utilization, energy, reliability)
- Cross-layer optimization

Included in Eaton's Intelligence Platform for data centers since 2021

- IoT and Machine Learning to the rescue

- PMSM: new sensors to understand power consumption
- TheSPoT: Thermal stress-aware power management to increase MTTF in servers (up to 2x)
- MARL: Multi-agent RL for efficient DC power distribution



An innovative method of saving the energy consumed by data centers has been invented by EPFL scientists and applied for Credit Suisse in Switzerland. The solution, developed at the **Embedded Systems Laboratory at EPFL**, will save up to 50% of the energy currently used.

The **Power Monitor System and Management** uses a set of (probably Hall) sensors connected to the server racks' main power cables and measures the current passing through. Then, the consumption is logged and sent to a software feedback system that adjusts the load on each server.

"Two servers running at 40% of their capacity each, consume much more than only one at 80%," said David Atienza, ESL director.

The system has already been implemented on the racks of some 5,200 servers in **Credit Suisse's Zurich datacenter**. The institution had been planning such a "virtualization" approach for about six years.



# Thank You! Questions?

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- **Energy- and sustainability-aware design and scheduling of datacenters and Cloud computing systems**
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